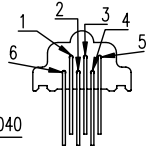
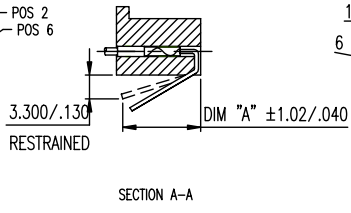
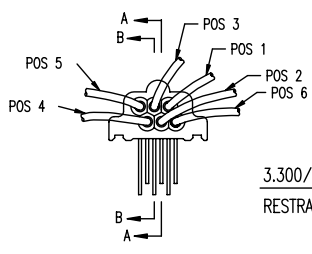
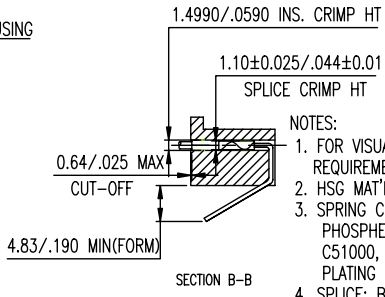
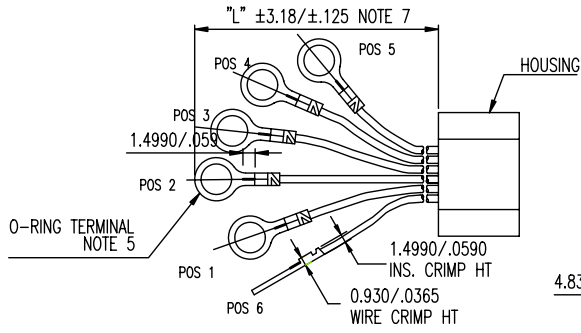


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PRODUCT NO.  
SEE TABLE



- NOTES:
- FOR VISUAL, MECHANICAL AND FUNCTIONAL REQUIREMENTS, SEE PRODUCT SPECIFICATION.
  - HSG MAT'L AND COLOR: SEE CHART.
  - SPRING CONTACT: PHOSPHER BRONZE ALLOY PER UNS C51000, 0.46MM/.018INCH DIA. PLATING SEE CHART.
  - SPLICE: BRASS ALLOY PER UNS C26000, PLATING SEE CHART.
  - RING TERMINAL: BRASS ALLOY PER UNS C26000, TIN-PLATED, THICKNESS 30u" MIN, O.D.=5.0MM, I.D.=3.2MM.
  - INS. WIRE: PER UL1061 AWG27, OTHERWISE SPECIFIED. WIRE STYLE SEE CHART.
  - TOL. OF WIRE LENGTH DIM L:  
± 3.15/.125: WHEN L<=234.95/9.25  
+ 6.35/.25: WHEN L>234.95/9.25
  - P/N WITH SUFFIX "LF" IS LEAD FREE P/N. SNPB PLATING IS CHANGED TO PURE TIN FOR LEAD FREE P/N'S.
  - PACKING STANDARD GS-14-920 WILL BE APPLIED FOR LEAD FREE P/N'S.
  - FOR LEAD FREE P/S THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
  - THE PRODUCT IS NOT INTENDED TO BE EXPOSED TO A MANUFACTURING SOLDER PROCESS.
  - EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOEMR .

mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		FCI www.fciconnect.com		
B	T20074	Y L	04/08/94	linear	.0 ± 0.25	projection	title 625F MODJACK ASSY WITH O-RING TERMINAL				
C	T40188	T C	07/12/94		.00 ± 0.13		product family MODJACK				
D	T60037	T C	01/26/96	angles	.000 ± 0.05		size dwg no 77199				
E	N0002	T C	03/15/00	dr	M CHENG	7/13/01		code NAN			
F	N10143	M C	07/19/01	enqr	M CHENG	7/13/01		sheet 1 of 1			
G	N05-0261	Z C	09/18/05	chr	M CHENG	7/18/01					
H	N08-0097	SH	09/25/08	appd	J HSIA	7/20/01					
sheet index	revision sheet	H	H	H	H						

path no.

PDM: Rev:H 3 STATUS:Released Printed: Aug 01, 2010





